### PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT5146141

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
CHOONGHYUN LEE	09/17/2018
KANGGUO CHENG	09/14/2018
JUNTAO LI	09/14/2018
SHOGO MOCHIZUKI	09/14/2018

### **RECEIVING PARTY DATA**

Name:	INTERNATIONAL BUSINESS MACHINES CORPORATION
Street Address:	NEW ORCHARD ROAD
City:	ARMONK
State/Country:	NEW YORK
Postal Code:	10504

#### **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	16134203

### **CORRESPONDENCE DATA**

**Fax Number:** (860)286-0115

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

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Address Line 2: 22ND FLOOR

Address Line 4: HARTFORD, CONNECTICUT 06103

ATTORNEY DOCKET NUMBER:	P201802118US01
NAME OF SUBMITTER:	MATTEO D. PEDINI
SIGNATURE:	/MATTEO D. PEDINI/
DATE SIGNED:	09/18/2018
DATE SIGNED:	
	This document serves as an Oath/Declaration (37 CFR 1.63).

**Total Attachments: 8** 

PATENT REEL: 046899 FRAME: 0947

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PATENT REEL: 046899 FRAME: 0948

# DECLARATION (37 C.F.R. § 1.63) FOR UTILITY PATENT APPLICATION USING AN APPLICATION DATA SHEET (37 C.F.R. § 1.76) AND ASSIGNMENT

## Title of Invention: INNER SPACER FORMATION AND CONTACT RESISTANCE REDUCTION IN NANOSHEET TRANSISTORS

As a below named and undersigned inventor, I hereby declare that:
This declaration is directed to the attached application, or (if following box is checked):
[ ] United States application or PCT international application number
The above-identified application was made or authorized to be made by me.
I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.
I have reviewed and understand the contents of the application, including the claims.
I am aware of the duty to disclose to the United States Patent and Trademark Office all information known to me to be material to patentability as defined in 37 C.F.R. § 1.56.
Whereas, I ("ASSIGNOR") have made certain inventions, improvements, and discoveries (herein referred to as the "Invention") disclosed in the above-identified patent application and further identified by the IBM Docket Number provided above in the header of this document;
Whereas, International Business Machines Corporation (herein referred to as the "ASSIGNEE"), a

Whereas, International Business Machines Corporation (herein referred to as the "ASSIGNEE"), a corporation of New York having a place of business at Armonk, New York, desires to acquire, and I desire to grant to the ASSIGNEE, my entire worldwide right, title, and interest in and to the Invention and in and to any and all patent applications and patents directed thereto;

Now, therefore, for good and valuable consideration, the receipt and sufficiency thereof being hereby acknowledged, I hereby sell or have sold, assign or have assigned, and otherwise transfer or have transferred to the ASSIGNEE, its successors, legal representatives, and assigns, my entire worldwide right, title, and interest in and to the Invention, the above-identified United States patent application, and any and all other patent applications and patents for the Invention which may be applied for or granted therefor in the United States and in all foreign countries and jurisdictions, including all divisions, continuations, reissues, reexaminations, renewals, extensions, counterparts, substitutes, and extensions thereof, and all rights of priority resulting from the filing of such applications and granting of such patents. In addition, I hereby authorize and request the Director of the United States Patent and Trademark Office to issue any United States Patent, and foreign patent authorities to issue any foreign patent, granted for the Invention, to the ASSIGNEE, its successors, legal representatives, and assigns, my entire worldwide right, title, and interest in and to the same to be held and enjoyed by the ASSIGNEE, its successors, legal representatives, and assigns to the full end of the terms for which any and all such patents may be granted, as fully and entirely as would have been held and enjoyed by me had this Assignment not been made; and I agree to execute any and all documents and instruments and perform all lawful acts reasonably related to recording this Assignment or perfecting title to the Invention and all related patents and applications, in the ASSIGNEE, its successors, legal representatives, and assigns, whenever requested by the ASSIGNEE, its successors, legal representatives, or assigns.

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I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. § 1001 by fine or imprisonment of not more than five (5) years, or both.

Signature: Choomy Hyun Lee	Date: 9/17/2018
(1) Legal Name of Inventor: Choonghyun LEE	
Signature:	Date:
(2) Legal Name of Inventor: Kangguo CHENG	
Signature:	Date:
2.8 _ 3.1	
(3) Legal Name of Inventor: Juntao LI	
	a.

(4) Legal Name of Inventor: Shogo MOCHIZUKI

Page 2 of 2

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Signature:	Date:
(1) Legal Name of Inventor: Choonghyun LEE	
Signature:	9/14/2018 Date:
(2) Legal Name of Inventor: Kangguo CHENG	
Signature:	Date:
(3) Legal Name of Inventor: Juntao LI	
Signature:	Date:

(4) Legal Name of Inventor: Shogo MOCHIZUKI

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Date:	
Date:	9/14/2018
Date:	
	Date:

(4) Legal Name of Inventor: Shogo MOCHIZUKI

IBM DOCKET NUMBER: P201802118US01

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Signature:	Date:
(1) Legal Name of Inventor: Choonghyun LEI	E
Signature:	Date:
(2) Legal Name of Inventor: <b>Kangguo CHENO</b>	G
Signature:	Date:
(3) Legal Name of Inventor: Juntao LI	Butc.
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Page 2 of 2

(4) Legal Name of Inventor: Shogo MOCHIZUKI